

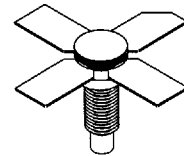
**The RF Line**  
**UHF Linear Power Transistor**

Designed for 4.0 watt stages in Band V TV transposer amplifiers. Gold metallized dice and diffused emitter ballast resistors are used to enhance reliability, ruggedness and linearity.

- Band IV and V (470–860 MHz)
- 4.0 W —  $P_{ref}$  @ -60 dB IMD
- 25 V —  $V_{CC}$
- High Gain — 7.0 dB Min, Class A @  $f = 860$  MHz
- Gold Metallization for Reliability

**TPV598**

**4.0 W, 470–860 MHz**  
**UHF LINEAR**  
**POWER TRANSISTOR**



**CASE 244-04, STYLE 1**  
**(.280 SOE)**

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	$V_{CEO}$	27	Vdc
Collector–Base Voltage	$V_{CBO}$	45	Vdc
Emitter–Base Voltage	$V_{EBO}$	4.0	Vdc
Operating Junction Temperature	$T_J$	200	°C
Storage Temperature Range	$T_{stg}$	-65 to +200	°C

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case ( $T_C = 70^\circ\text{C}$ )	$R_{\theta JC}$	6.2	°C/W
Thermal Resistance, Case to Heatsink	$R_{\theta CH}$	0.4 Typ	°C/W

**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Typ	Max	Unit
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**OFF CHARACTERISTICS**

Collector–Emitter Breakdown Voltage ( $I_C = 60$ mA, $I_B = 0$ )	$V_{(BR)CEO}$	27	—	—	Vdc
Collector–Base Breakdown Voltage ( $I_C = 10$ mA, $I_E = 0$ )	$V_{(BR)CBO}$	45	—	—	Vdc
Emitter–Base Breakdown Voltage ( $I_E = 3.0$ mA, $I_C = 0$ )	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector–Emitter Leakage Current ( $V_{CE} = 20$ V)	$I_{CEO}$	—	—	5.0	mA

**ON CHARACTERISTICS**

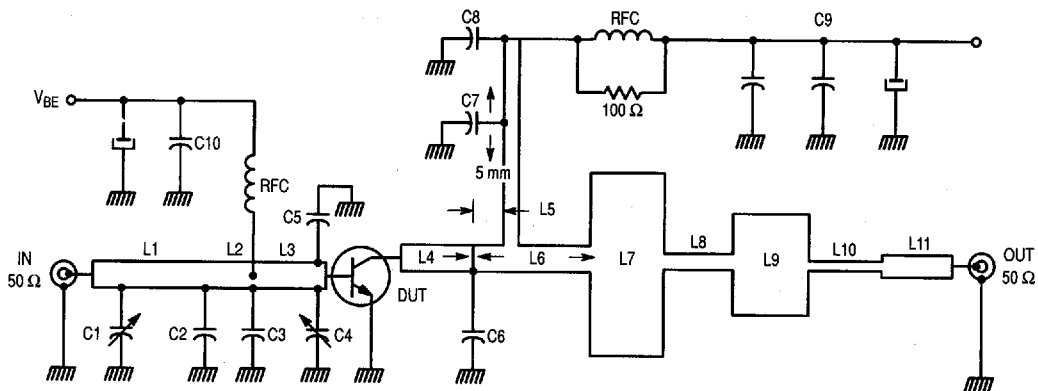
DC Current Gain ( $I_C = 500$ mA, $V_{CE} = 20$ V)	$h_{FE}$	10	—	—	—
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**DYNAMIC CHARACTERISTICS**

Output Capacitance ( $V_{CB} = 25$ V, $I_E = 0$ , $f = 1.0$ MHz)	$C_{ob}$	—	—	20	pF
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**FUNCTIONAL TESTS**

Common–Emitter Amplifier Power Gain ( $V_{CE} = 25$ V, $P_{out} = 4.0$ W, $f = 860$ MHz, $I_C = 850$ mA)	$G_{PE}$	7.0	—	—	dB
Intermodulation Distortion, 3 Tone ( $f = 860$ MHz, $V_{CE} = 25$ V, $I_E = 850$ mA, $P_{ref} = 4.0$ W, Vision Carrier = -8.0 dB, Sound Carrier = -7.0 dB, Sideband Signal = -16 dB, Specification TV05001)	IMD <sub>1</sub>	—	—	-58	dB
Cutoff Frequency ( $V_{CE} = 25$ V, $I_C = 850$ mA)	$f_c$	—	2.0	—	GHz



- C1 — Variable 0.5–4.7 pF Airtronic
- C2, C3 — ATC 4.7 pF
- C4 — ATC 10 pF + Variable 0.5–4.7 pF Airtronic
- C5 — ATC 10 pF + ATC 5.6 pF
- C6 — ATC 18 pF + 0.5–4.7 pF Variable Airtronic
- C7 — 470 pF Chip Capacitor
- C8 — 1.0 nF + 10 nF Decoupling
- C9 — 1.0 nF + 10 nF + 0.1 μF + 10 μF
- C10 — 10 nF + 1.0 μF + 10 μF
- RFC = 8 turns, ID 2.5 mm, Wire = 0.5 mm

- L1 — 50 Ω line 6.2% λg at 860 MHz
- L2 — 50 Ω line 4.2% λg at 760 MHz
- L3 — 50 Ω line 4.9% λg at 860 MHz
- L4 — 20 Ω line 6.5% λg at 860 MHz
- L5 — 50 Ω line 5% λg at 860 MHz
- L6 — 20 Ω line 9.5% λg at 860 MHz
- L7 — 4.0 Ω line 8% λg at 860 MHz
- L8 — 55 Ω line 7.5% λg at 860 MHz
- L9 — 7.5 Ω line 8% λg at 860 MHz
- L10 — 100 Ω line 8% λg at 860 MHz
- L11 — 20 Ω line 8% λg at 860 MHz

Note: λg is the wavelength in the microstrip circuit

Figure 1. Broadband Test Circuit

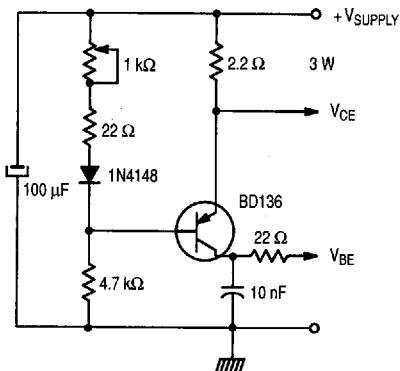


Figure 2. Class A Bias Circuit